

Description

The FDS8984 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

VDS = 30V ID = 8.5 A

 $R_{DS(ON)} < 18m\Omega @ V_{GS}=4.5V$

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

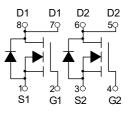
Product ID	Pack	Brand	Qty(PCS)	
FDS8984	SOP-8	HXY MOSFET	3000	

Absolute Maximum Ratings@T_i=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	<u>+</u> 20	V
I _D @T _A =25℃	Drain Current, V _{GS} @ 4.5V ³	8.5	А
I₀@T₄=70°C	Drain Current, V _{GS} @ 4.5V ³	5.8	A
Ідм	Pulsed Drain Current ¹	37	A
₽ _D @T _A =25°C	Total Power Dissipation	1.5	W
Тята	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-a	Maximum Thermal Resistance, Junction- ambient ³	85	°C/W



SOP-8



Dual N-Channel MOSFET



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V	
$\bigtriangleup BV_{\text{DSS}} / \bigtriangleup T_J$	BVDSS Temperature Coefficient	Reference to 25° C , I _D =1mA		0.034		V/°C	
Р	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =7A	15 18		18		
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =4A		22	28	mΩ	
$V_{GS(th)}$	Gate Threshold Voltage		1.2		2.5	V	
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	V _{GS} -V _{DS} , ID -2300A		-5.8		mV/°C	
	Drain-Source Leakage Current	V_{DS} =24V , V_{GS} =0V , T_J =25°C			1	uA	
I _{DSS}		V_{DS} =24V , V_{GS} =0V , T_{J} =55°C	T_=55°C		5	- uA	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =7A		6		S	
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.5		Ω	
Qg	Total Gate Charge (4.5V)			6			
Q _{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =7A		2.5		nC	
Q_{gd}	Gate-Drain Charge			2.1			
T _{d(on)}	Turn-On Delay Time			2.4			
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_G =3.3 Ω		7.8		ns	
$T_{d(off)}$	Turn-Off Delay Time	I _D =7A		22			
T _f	Fall Time			4			
C _{iss}	Input Capacitance			572			
Coss	Output Capacitance	V_{DS} =15V , V_{GS} =0V , f=1MHz		80		pF	
C _{rss}	C _{rss} Reverse Transfer Capacitance			65			
ls	Continuous Source Current ^{1,5}				7.3	А	
I _{SM}	Pulsed Source Current ^{2,5}	urrent ^{2,5} V _G =V _D =0V , Force Current			37	А	
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V	
t _{rr}	Reverse Recovery Time			20		nS	
Q _{rr}	Reverse Recovery Charge I⊧=7A , dI/dt=100A/µs , Tյ=25°C			1.1		nC	

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Note :

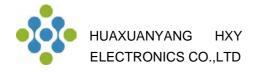
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS}=21A

4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

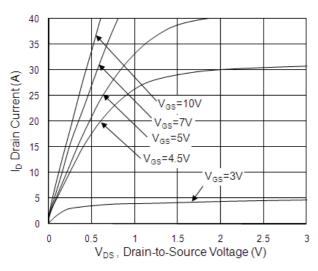


Fig.1 Typical Output Characteristics

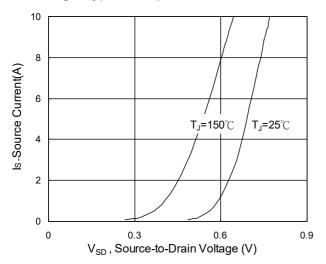


Fig.3 Forward Characteristics Of Reverse

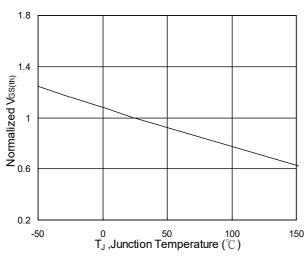


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

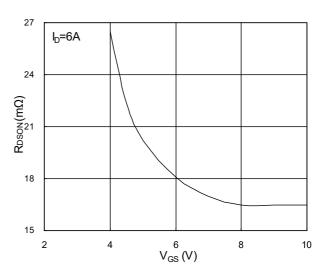


Fig.2 On-Resistance vs. G-S Voltage

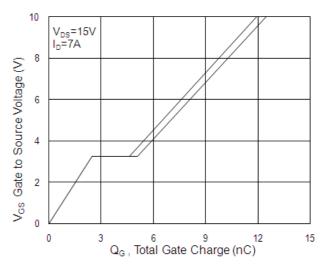


Fig.4 Gate-Charge Characteristics

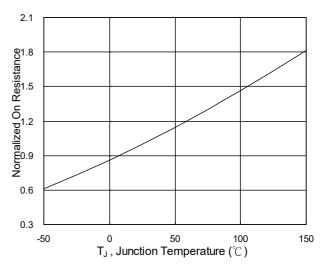
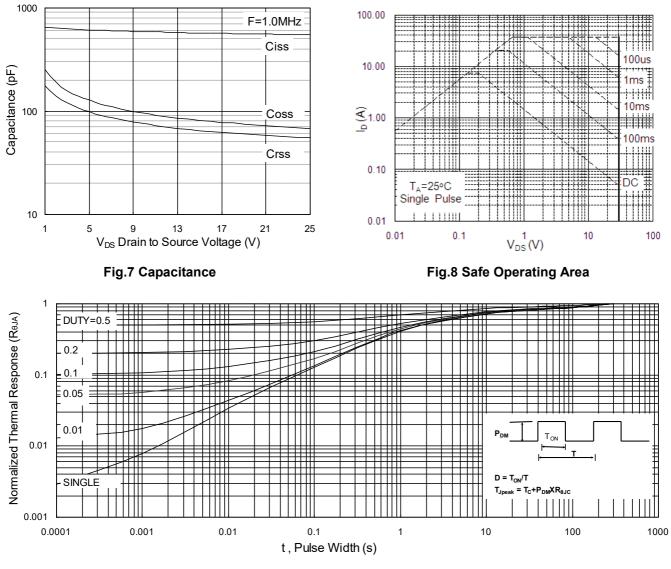


Fig.6 Normalized R_{DSON} vs. T_J







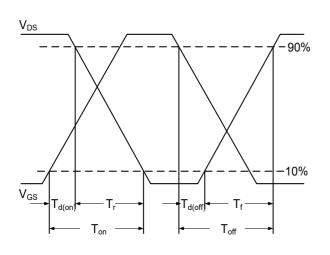


Fig.10 Switching Time Waveform

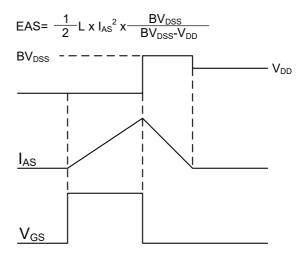
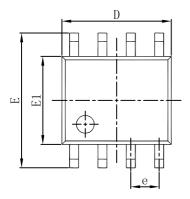
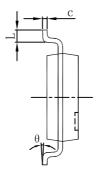


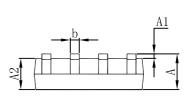
Fig.11 Unclamped Inductive Switching Waveform



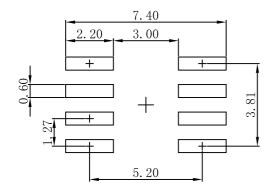
SOP-8 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	



Note: 1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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